## KEMET Part Number: C0805X331J1GACTU

(C0805X331J1GAC7800)



SMD Comm C0G Flex, Ceramic, 330 pF, 5%, 100 VDC, C0G, SMD, MLCC, FT-CAP, Ultra-Stable, 0805



Dimensions		
Chip Size	0805	
L	2mm +/-0.3mm	
W	1.25mm +/-0.3mm	
Т	0.78mm +/-0.20mm	
S	0.75mm MIN	
В	0.5mm +/-0.25mm	

Packaging Specifications		
Packaging:	T&R, 180mm, Plastic Tape	
Packaging Quantity:	4000	

General Information	
Series:	SMD Comm C0G Flex
Style:	SMD Chip
Description:	SMD, MLCC, FT-CAP, Ultra- Stable
Features:	FT-CAP, Ultra-Stable
RoHS:	Yes
Termination:	Flexible Termination
Marking:	No
AEC-Q200:	No
Component Weight:	11 mg
Shelf Life:	78 Weeks
MSL:	1

Specifications		
Capacitance:	330 pF	
Measurement Condition:	1 MHz 1.0Vrms	
Capacitance Tolerance:	5%	
Voltage DC:	100 VDC	
Dielectric Withstanding Voltage:	250 VDC	
Temperature Range:	-55/+125°C	
Temperature Coefficient:	COG	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1MegaHz 1.0Vrms	
Dissipation Factor:	0.1% 1 MHz 1.0Vrms	
Aging Rate:	0% Loss/Decade Hour	
Insulation Resistance:	100 GOhms	

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